# Very Low Forward Voltage Trench-based Schottky Rectifier

# Exceptionally Low $V_F = 0.41 \text{ V}$ at $I_F = 5 \text{ A}$

### **Features**

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# **Typical Applications**

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

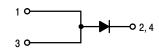
### **Mechanical Characteristics**

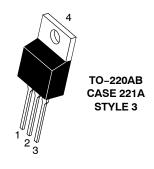
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Weight (Approximately): 1.9 grams
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



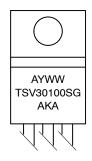
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#### **MARKING DIAGRAM**



A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package
AKA = Polarity Designator

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTSV30100SG	TO-220 (Pb-Free/ Halide-Free)	50 Units/Rail

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 105^{\circ}C$ )	I <sub>F(AV)</sub>	30	А
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 95°C)	I <sub>FRM</sub>	60	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	А
Operating Junction Temperature	TJ	-40 to +150	°C
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# THERMAL CHARACTERISTICS

Rating			Value	Unit
Maximum Thermal Resistance	Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.0 70	°C/W

# **ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1)	VF			V
$(I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C})$		0.47	_	
$(I_F = 10 \text{ A}, T_J = 25^{\circ}\text{C})$		0.57	_	
$(I_F = 30 \text{ A}, T_J = 25^{\circ}\text{C})$		0.915	1.1	
(I <sub>F</sub> = 5 A, T <sub>J</sub> = 125°C)		0.41	_	
$(I_F = 10 \text{ A}, T_J = 125^{\circ}\text{C})$		0.54	_	
$(I_F = 30 \text{ A}, T_J = 125^{\circ}\text{C})$		0.78	0.85	
Maximum Instantaneous Reverse Current (Note 1)	I <sub>R</sub>			
$(V_R = 70 \text{ V}, T_J = 25^{\circ}\text{C})$		12		μΑ
$(V_R = 70 \text{ V}, T_J = 125^{\circ}\text{C})$		11		mA
(Rated dc Voltage, T <sub>J</sub> = 25°C)		55	1000	μΑ
(Rated dc Voltage, T <sub>J</sub> = 125°C)		27	60	mΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1.</sup> Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

#### **TYPICAL CHARACTERISTICS**

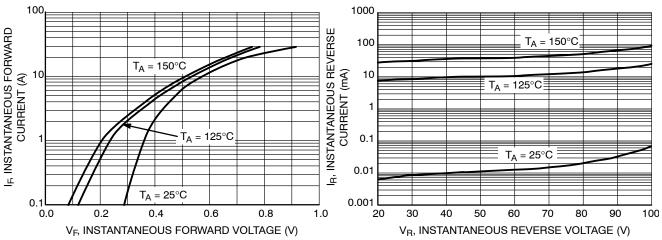


Figure 1. Typical Instantaneous Forward Characteristics

Figure 2. Typical Reverse Characteristics

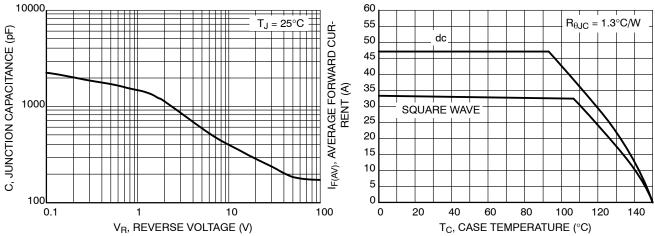


Figure 3. Typical Junction Capacitance

Figure 4. Current Derating, Case

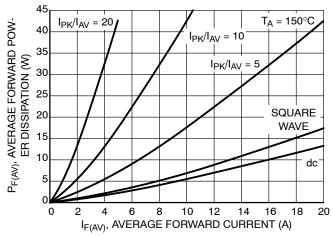


Figure 5. Forward Power Dissipation

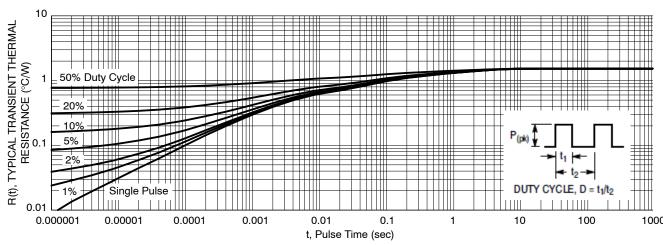
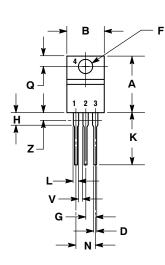
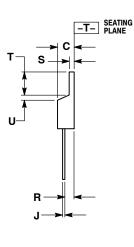


Figure 6. Typical Transient Thermal Response, Junction-to-Case

#### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 





#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 3: PIN 1. CATHODE

- ANODE 2.
- 3. GATE
- ANODE

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